INTEGRATED CIRCUITS

DATA SHEET

TDA3604Q; TDA3604TH Multiple voltage regulators with external reset delay and switch

Product specification Supersedes data of 1997 Aug 15 File under Integrated Circuits, IC01 1997 Aug 21





Multiple voltage regulators with external reset delay and switch

TDA3604Q; TDA3604TH

FEATURES

General

- One V_P-state controlled regulator (regulator 2)
- Regulator 2, reset and ignition buffer operate during load dump and thermal shutdown
- Separate control pins for switching regulator 1 and the power switch
- Supply voltage range of –18 to +50 V (operating from 9.75 V)
- Low reverse current of regulator 2
- Low quiescent current (when regulator 1, power switch and ignition buffer are switched off)
- Ignition input/output
- · Reset output
- · Adjustable reset delay time
- · High ripple rejection
- · Power switch
- Separate supply for the power switch.

Protections

- Reverse polarity safe (down to –18 V without high reverse current)
- Able to withstand voltages up to 18 V at the outputs (supply line may be short-circuited)
- · ESD protected on all pins
- Thermal protection
- · Load dump protection
- · Foldback current limit protection for regulators 1 and 2
- Delayed second current limit protection for the power switch
- The regulator outputs and the power switch are DC short-circuited safe to ground and V_P.

GENERAL DESCRIPTION

The TDA3604Q and TDA3604TH are multiple output voltage regulators with a power switch, intended for use in car radios with or without a microcontroller.

It contains one fixed voltage regulator with a foldback current protection (regulator 1) and one fixed voltage regulator (regulator 2), intended to supply a microcontroller, that also operates during load dump and thermal shutdown.

There is a power switch with protections, operated by an enable input.

The reset and ignition outputs can be used to interface by the microcontroller. The reset signal can be used to call up the microcontroller and the ignition output indicates ignition voltage available.

Both supply pins can withstand load dump pulses and negative supply voltages.

Regulator 2 will be switched on at a supply voltage >6.5 V and off at a voltage of regulator 2 <1.9 V.

ORDERING INFORMATION

TYPE		PACKAGE	
NUMBER	NAME	DESCRIPTION	VERSION
TDA3604Q	DBS13P	plastic DIL-bent-SIL power package; 13 leads (lead length 12 mm)	SOT141-6
TDA3604TH	HSOP20	plastic heat-dissipating small outline package; 20 leads; low stand-off	SOT418-2

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QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply			•	•	•	
V _P	supply voltage					
	operating		9.75	14.4	25	V
	regulator 2 on	note 1	2.4	14.4	25	V
	jump start	t ≤ 10 minutes	_	_	30	V
	load dump protection	during 50 ms; $t_r \ge 2.5$ ms	_	_	50	V
Iq	total quiescent current	standby mode	_	400	500	μΑ
T _{vj}	operating virtual junction temperature		_	_	150	°C
Voltage re	gulators			•		•
V _{REG1}	output voltage regulator 1	$0.5 \text{ mA} \le I_{REG1} \le 300 \text{ mA}$	8.65	9.0	9.35	V
V _{REG2}	output voltage regulator 2	$0.5 \text{ mA} \le I_{REG2} \le 50 \text{ mA}; V_P = 14.4 \text{ V}$	4.8	5.0	5.2	V
V _{REGd1}	drop-out voltage regulator 1	I _{REG1} = 0.3 A; note 2	_	-	0.5	V
Power swi	itch					
V _{swd}	drop-out voltage	I _{sw} = 0.5 A; note 3	_	<u> </u>	1.4	V
I _{swM}	peak current	t ≤ 10 ms	1.4	_	_	А

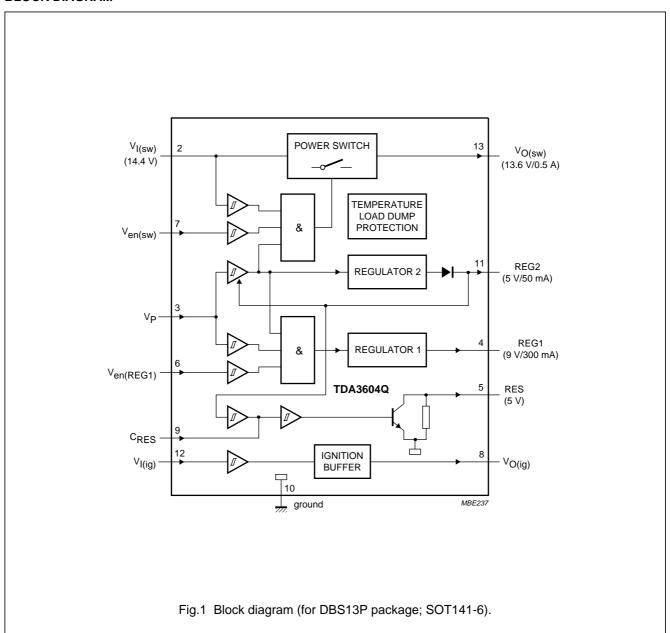
Notes

- 1. Minimum operating voltage, only if V_P has exceeded 6.5 V.
- 2. The drop-out voltage of regulator 1 is measured between V_P and V_{REG1} .
- 3. The drop-out voltage of the power switch is measured between $V_{I(sw)}$ and $V_{O(sw)}$.

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BLOCK DIAGRAM

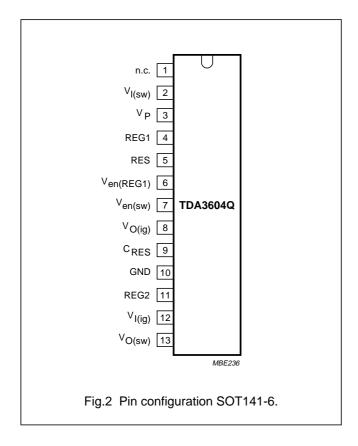


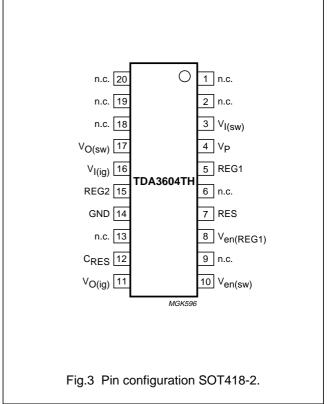
Multiple voltage regulators with external reset delay and switch

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PINNING

CVMDOL		PIN	DESCRIPTION	
SYMBOL	SOT141-6	SOT418-2	DESCRIPTION	
n.c.	1	1, 2, 6, 9, 13, 18, 19 and 20	not connected	
V _{I(sw)}	2	3	power switch input	
V _P	3	4	supply voltage	
REG1	4	5	regulator 1 output	
RES	5	7	reset output (+5 V)	
V _{en(REG1)}	6	8	regulator 1 enable input	
V _{en(sw)}	7	10	power switch enable input	
V _{O(ig)}	8	11	ignition output	
C _{RES}	9	12	reset delay capacitor	
GND	10	14	ground (0 V)	
REG2	11	15	regulator 2 output	
V _{I(ig)}	12	16	ignition input	
V _{O(sw)}	13	17	power switch output	





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FUNCTIONAL DESCRIPTION

The TDA3604Q and TDA3604TH are multiple output voltage regulators with a power switch, intended for use in car radios with or without a microcontroller. Because of low-voltage operation of the car radio, low-voltage drop regulators are used.

Regulator 2 will switch on when the supply voltage exceeds 6.5 V for the first time and will switch off again when the output voltage of regulator 2 drops below 1.9 V (this is below an engine start). When regulator 2 is switched on and the output voltage of this regulator is within its voltage range, the reset output will be enabled (reset will go HIGH via a pull-up resistor) to generate a reset to the microcontroller. The reset cycles can be extended by an external capacitor at C_{RES} (pin of the reset delay capacitor). The above mentioned start-up feature is built-in to secure a smooth start-up of the microcontroller at first connection, without uncontrolled switching of regulator 2 during the start-up sequence.

When both regulator 2 and the supply voltage ($V_P > 4.5 \text{ V}$) are available, regulator 1 and the power switch can be operated by the enable inputs $V_{en(REG1)}$ and $V_{en(sw)}$ respectively.

All output pins are fully protected. The regulators are protected against load dump (regulator 1 will switch off at supply voltages higher than 25 V) and short-circuit (foldback current protection).

The power switch contains a current protection which is delayed for \geq 10 ms (in short-circuit condition). During this time the current is limited to 1.4 A ($V_P \leq$ 18 V).

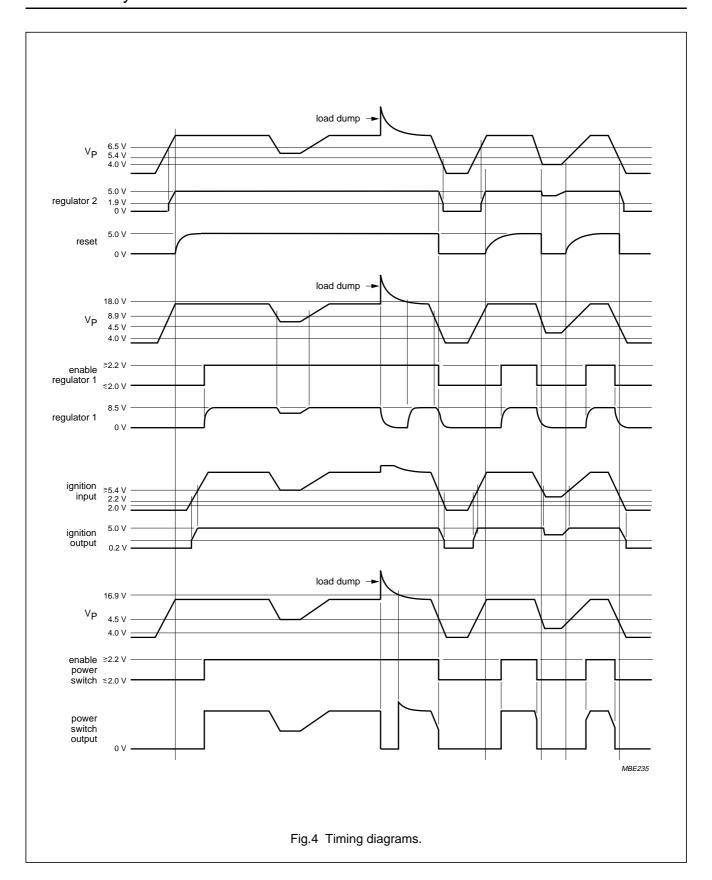
At supply voltages over 16.9 V the power switch is clamped at 15.0 V (to avoid externally connected circuitry being damaged by an overvoltage) and the power switch will switch off at load dump.

Interfacing with the microcontroller can be accomplished by an ignition Schmitt trigger and ignition output buffer, (simple full/semi on/off logic applications).

The total timing of a semi on/off logic set is shown in Fig.4.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _P	supply voltage				
	operating		_	25	V
	reverse polarity	non-operating	_	-18	V
	jump start	t ≤ 10 minutes	_	30	V
	load dump protection	during 50 ms; $t_r \ge 2.5$ ms	_	50	V
V_{ppi}	positive pulse voltage at ignition buffer	$V_P = 14.4 \text{ V}; R_I = 1 \text{ k}\Omega$	_	50	V
V_{npi}	negative pulse voltage at ignition buffer	$V_P = 14.4 \text{ V}; R_I = 1 \text{ k}\Omega$	_	-100	V
T _{stg}	storage temperature	non-operating	-55	+150	°C
T_{vj}	operating virtual junction temperature		-40	+150	°C
P _{tot}	total power dissipation		_	15.6	W

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-c}	thermal resistance from junction to case	8	K/W
R _{th j-a}	thermal resistance from junction to ambient in free air	50	K/W

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CHARACTERISTICS

 V_P = $V_{I(sw)}$ = 14.4 V; T_{amb} = 25 $^{\circ}C;$ see Fig.7; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply			•	•	•	
V _P	supply voltage					
	operating		9.75	14.4	25	V
	regulator 2 on	note 1	2.4	14.4	25	V
	jump start	t ≤ 10 minutes	_	_	30	V
	load dump protection	during 50 ms; $t_r \ge 2.5$ ms	_	_	50	V
Iq	quiescent supply current	V _P = 12.4 V; note 2	_	400	500	μΑ
		V _P = 14.4 V; note 2	_	420	_	μΑ
Schmitt tr	igger power supply for the pov	ver switch				
V _{thr}	rising threshold voltage		4.0	4.5	5.0	V
V _{thf}	falling threshold voltage		3.5	4.0	4.5	V
V _{hys}	hysteresis voltage		_	0.5	_	V
Schmitt tr	igger power supply for regulat	or 1				
V _{thr}	rising threshold voltage		4.0	4.5	5.0	V
V _{thf}	falling threshold voltage		3.5	4.0	4.5	V
V _{hys}	hysteresis voltage		_	0.5	_	V
Schmitt tr	igger for regulator 2			•	•	
V _{thr}	rising threshold voltage		6.0	6.5	7.1	V
V_{thf}	falling threshold voltage		1.7	1.9	2.2	V
V _{hys}	hysteresis voltage		_	4.7	_	V
Schmitt tr	igger for enable input (of regul	ator 1 and power switch)				
V _{thr}	rising threshold voltage		1.7	2.2	2.7	V
V _{thf}	falling threshold voltage		1.5	2.0	2.5	V
V _{hys}	hysteresis voltage		_	0.2	_	V
Schmitt tr	igger for reset buffer				•	
V _{r(REG2)}	rising voltage of regulator 2	note 3	_	V _{REG2} – 0.15	_	V
V _{f(REG2)}	falling voltage of regulator 2	note 3	_	V _{REG2} - 0.25	_	V
V _{spread}	voltage spread on tracking	note 4	_	10	_	mV
	igger for ignition buffer	•		•	•	•
V_{thr}	rising threshold voltage		1.7	2.2	2.7	V
V _{thf}	falling threshold voltage		1.5	2.0	2.5	V
V _{hys}	hysteresis voltage		_	0.2	_	V
Reset buf	fer			•	•	•
I _{sink}	LOW-level sink current	V _{RES} ≤ 0.8 V	15	20	_	mA
I _{leak}	leakage current	V _P = 14.4 V; V _{RES} = 5 V	25	50	100	μΑ

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Ignition bu	uffer			!	!	
V _{OL}	LOW-level output voltage	I _{OL} = 0	0	0.2	0.8	V
V _{OH}	HIGH-level output voltage	note 5	_	5.0	5.2	V
I _{OL}	LOW-level output current	V _{OL} ≤ 0.8 V	0.3	0.8	_	mA
I _{OH}	HIGH-level output current	V _{OH} ≥ 3 V	0.3	2.0	_	mA
Regulator	1; note 6					•
V _{REG1}	output voltage off		_	1	400	mV
V _{REG1}	output voltage	0.5 mA ≤ I _{REG1} ≤ 300 mA	8.65	9.0	9.35	V
		10 V ≤ V _P ≤ 18 V	8.65	9.0	9.35	V
ΔV_{REG1}	line regulation	10 V ≤ V _P ≤ 18 V	_	_	50	mV
ΔV_{REGL1}	load regulation	0.5 mA ≤ I _{REG1} ≤ 300 mA	_	_	70	mV
SVRR1	supply voltage ripple rejection	f _i = 200 Hz; V _I = 2 V (p-p)	60	_	_	dB
V _{REGd1}	drop-out voltage	I _{REG1} = 300 mA; note 7	_	0.4	0.5	V
I _{REGm1}	current limit	V _{REG1} > 7 V; note 8	0.45	_	1.2	Α
I _{REGsc1}	short-circuit current	$R_L \le 0.5 \Omega$; note 9	50	300	_	mA
$\alpha_{\rm ct}$	cross talk	note 10	_	50	_	dB
Regulator	2; note 11					1
V _{REG2}	output voltage	0.5 mA ≤ I _{REG2} ≤ 50 mA	4.8	5.0	5.2	V
REOZ		$7 \text{ V} \le \text{V}_{\text{P}} \le 18 \text{ V}$	4.8	5.0	5.2	V
		$18 \text{ V} \le \text{V}_{\text{P}} \le 50 \text{ V}$	4.75	5.0	5.25	V
ΔV_{REG2}	line regulation	7 V ≤ V _P ≤ 18 V	_	_	50	mV
ΔV_{REGL2}	load regulation	0.5 mA ≤ I _{REG1} ≤ 30 mA	_	_	50	mV
SVRR2	supply voltage ripple rejection	f _i = 200 Hz; V _I = 2 V (p-p)	60	_	_	dB
V _{REGd2}	drop-out voltage	I _{REG2} = 30 mA; note 12	_	0.3	0.4	V
I _{REGm2}	current limit	V _{REG2} > 4.5 V; note 8	0.1	_	0.5	Α
I _{REGsc2}	short-circuit current	$R_L \le 0.5 \Omega$; note 9	20	50	_	mA
α_{ct}	cross talk	note 13	_	50	_	dB
Power swi	itch		•	•	•	•
V _{swd}	drop-out voltage	I _{sw} = 0.5 A; note 14	_	0.8	1.4	V
I _{swcc}	continuous current		0.5	_	_	Α
V _{swcl}	clamping voltage	V _P ≥ 16.9 V	_	15.0	16.2	V
I _{swM}	peak current	t ≤ 10 ms	1.4	_	_	Α
V _{swfb}	fly back voltage behaviour	$I_{sw} = -200 \text{ mA}; V_P = 9 \text{ V}$	_	_	20	V
I _{lim(sw)}	current limit	$V_P = 14.4 \text{ V}; V_{sw} < 1.5 \text{ V};$ note 8	0.6	0.9	_	А
Reset dela	ay	•	'	•	•	•
I _O	output current		_	3	_	μΑ
V _{thr}	rising threshold voltage		2.7	3.0	3.3	V
t _d	delay time	C _I = 47 nF; note 15	25	50	100	ms

Multiple voltage regulators with external reset delay and switch

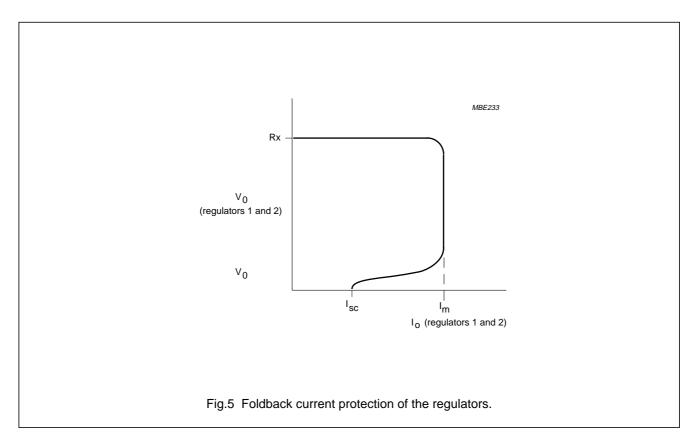
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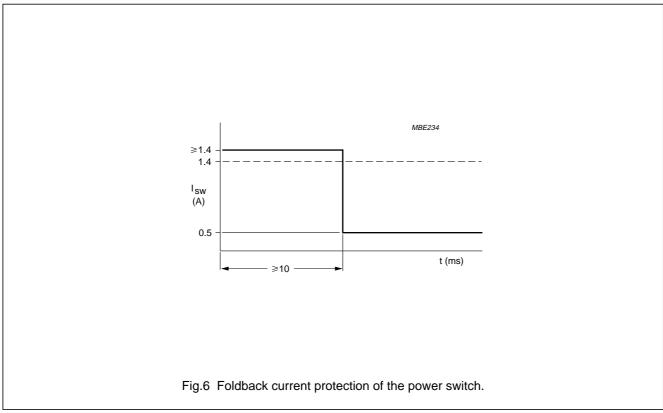
Notes to the characteristics

- 1. Minimum operating voltage, only if V_P has exceeded 6.5 V.
- 2. Enable inputs of regulator 1, ignition and power switch are low. Regulator 2 is unloaded.
- 3. Voltage drop due to load condition.
- 4. The spread on tracking is one sigma value.
- 5. Ignition output voltage will be less than or equal to the output voltage of regulator 2.
- 6. I_{REG1} = 5 mA unless otherwise specified.
- 7. The drop-out voltage of regulator 1 is measured between V_P and V_{REG1}.
- 8. At current limit, I_{REGm} is held constant (see Fig.5).
- 9. The foldback current protection limits the dissipated power at short-circuit (see Figs 5 and 6).
- 10. The cross talk of regulator 1 is measured with an $I_{REG2} = 0.5$ mA up to 30 mA and input frequency of $f_i = 100$ kHz.
- 11. I_{REG2} = 5 mA unless otherwise specified.
- 12. The drop-out voltage of regulator 2 is measured between V_P and V_{REG2}.
- 13. The cross talk of regulator 2 is measured with an $I_{REG1} = 0.5$ mA up to 100 mA and input frequency of $f_i = 100$ kHz.
- 14. The drop-out voltage of the power switch is measured between V_{I(sw)} and V_{O(sw)}.
- 15. The delay time depends on the value of the capacitor: $t_d = \frac{C}{I} \times V_{thrC} = C \times 2.5 \times 10^6$

Multiple voltage regulators with external reset delay and switch

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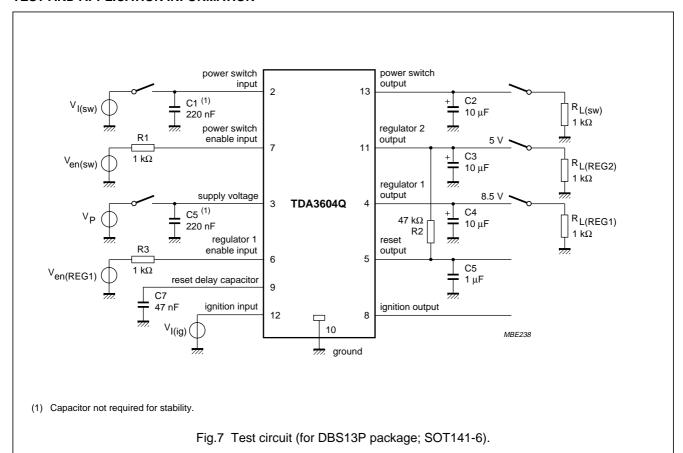




Multiple voltage regulators with external reset delay and switch

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TEST AND APPLICATION INFORMATION



Noise information

The noise at the output of the regulators depends on the bandwidth of the regulators, which can be adjusted by the output capacitors. Table 1 shows the noise figures.

Although stability is guaranteed when C_L is higher than 10 μ F (over temperature range) with tan (ϕ) = 1 in the frequency range 1 to 10 kHz, however, for low noise, a 47 μ F load capacitor is required.

The noise on the supply line depends on the value of the supply capacitor and is caused by a current noise (output noise of the regulators is translated into a current noise by the output capacitors). When a high frequency capacitor of 220 nF with an electrolytic capacitor of 100 μF in parallel is placed directly over V_P and GND (pins of supply voltage and ground) the noise is minimized.

Table 1 Noise figures

REGULATOR	NOISE (μV) ⁽¹⁾	OUTPUT CAPACITOR (μF)
	180	10
1	100	47
	80	100
	120	10
2	70	47
	70	100

Note

1. Bandwidth of 100 kHz.

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SHORT CIRCUIT BEHAVIOUR OF POWER SWITCH

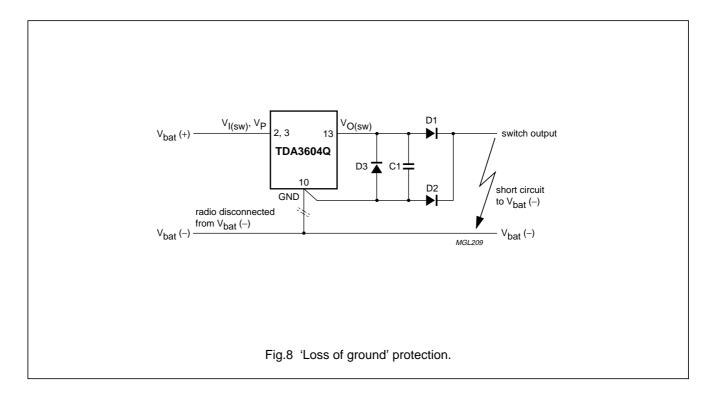
The short circuit behaviour of the switch with large inductive loads (switch output goes out of the radio) can be improved by replacing C2 (see Fig.7) by a larger electrolytic capacitor of 10 μ F/16 V. When the temperature protection of the switch becomes active, due to a short circuit of the switch, the behaviour will be improved.

When the switch is clamped an minimum output capacitor of 10 μF is needed.

The power switch is not protected against 'loss of ground' condition (= short of the switch to ground with floating ground pin of the TDA3604 itself). A 'loss of ground' situation can in practice only occur when the switch output goes outside the car-radio box.

There is an application solution to protect against 'loss of ground' (see Fig.8).

It is advisable to limit the dissipation at short circuit condition by monitoring the output of the power switch. The microprocessor can switch of the power switch when the switch was enabled and the switch output remains low due to a short circuit condition.



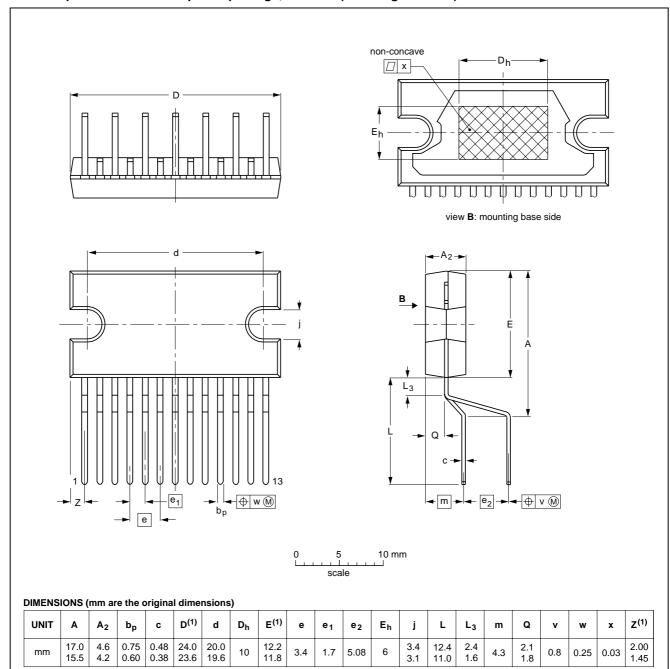
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PACKAGE OUTLINES

DBS13P: plastic DIL-bent-SIL power package; 13 leads (lead length 12 mm)

SOT141-6



Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

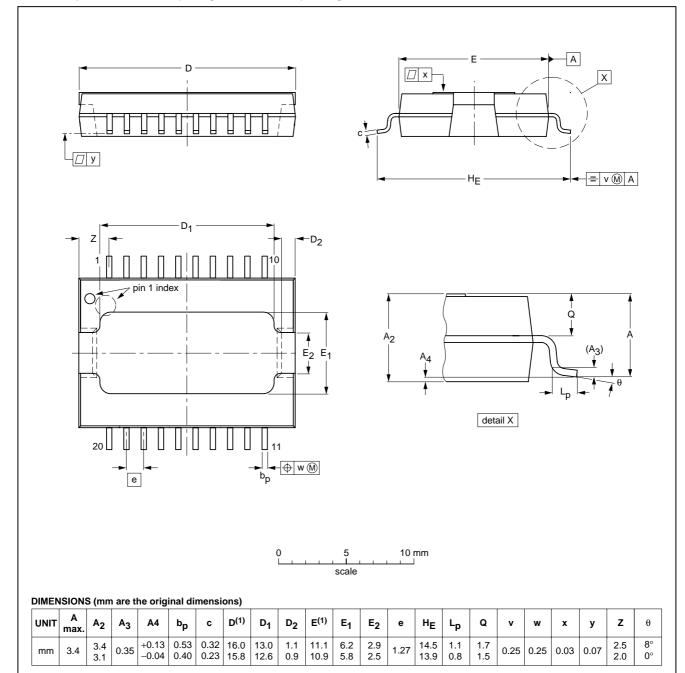
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT141-6					92-11-17 95-03-11

Multiple voltage regulators with external reset delay and switch

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HSOP20: plastic heat-dissipating small outline package; 20 leads; low stand-off

SOT418-2



Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT418-2					96-11-18

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SOLDERING

Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our "IC Package Databook" (order code 9398 652 90011).

DBS

SOLDERING BY DIPPING OR BY WAVE

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact

time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature (T_{stg max}). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

REPAIRING SOLDERED JOINTS

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

HSOP

No information available at the moment.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
"	accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or may cause permanent damage to the device. These are stress ratings only and operation

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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